Power MOSFET

30 V, 17 A, Single N-Channel, SOIC-8 Flat Lead

Features

- Fast Switching Times
- Low Gate Charge
- Low R_{DS(on)}
- Low Inductance SOIC-8 Package
- These are Pb-Free Devices

Applications

- Notebooks, Graphics Cards
- DC-DC Converters
- Synchronous Rectification

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	30	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain Current	Steady	T _A = 25°C	I _D	10.2	Α
(Note 1)	State	T _A = 85°C		7.4	
	t ≤ 10 s	T _A = 25°C		17	
Power Dissipation (Note 1)	Steady State T _A = 25°C		P_{D}	2.3	W
	t ≤ 10 s			6.25	
Continuous Drain Current	o	T _A = 25°C	I _D	6.9	Α
(Note 2)	Steady State	T _A = 85°C		4.9	
Power Dissipation (Note 2)		T _A = 25°C	P_{D}	1.0	W
Pulsed Drain Current $t_p \le 10 \mu s$			I _{DM}	51	Α
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to 150	°C
Source Current (Body Diode)			I _S	6.25	Α
Single Pulse Drain-to-Source Avalanche Energy (V_{DD} = 25 V, V_{GS} = 10 V, I_{PK} = 7.0 A, L = 10 mH, R_G = 25 Ω)			E _{AS}	245	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	55	°C/W
Junction-to-Ambient – t ≤ 10 s (Note 1)	$R_{\theta JA}$	20	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta,IA}$	122.5	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. Surface-mounted on FR4 board using 1 in sq pad size
- (Cu area = 1.127 in sq [1 oz] including traces).

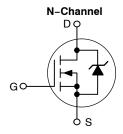
 2. Surface–mounted on FR4 board using the minimum recommended pad size (Cu area = 0.412 in sq).



ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
30 V	10 mΩ @ 10 V	17 A
00 0	13.5 mΩ @ 4.5 V	1774

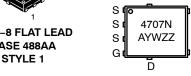




MARKING DIAGRAM & PIN ASSIGNMENT

D

D



4707N = Specific Device Code = Assembly Location

= Year W = Work Week = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4707NT1G	SOIC-8 FL (Pb-Free)	1500 / Tape & Reel
NTMFS4707NT3G	SOIC-8 FL (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS			•				
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				6.5		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	S T _J = 25°				1.0	μΑ
		$V_{GS} = 0 \text{ V}, V_{DS} = 24 \text{ V}$	T _J = 125°C			50	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$				±100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μA	1.0		2.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				5.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D =	: 10 A		10	13	mΩ
		V _{GS} = 4.5 V, I _D =	8.0 A		13.5	17	
Forward Transconductance	9FS	V _{DS} = 15 V, I _D = 10 A			20		S
CHARGES, CAPACITANCES AND GA	ATE RESISTAN	ICE	•		•	•	•
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 24 V			735		pF
Output Capacitance	C _{OSS}				295		1
Reverse Transfer Capacitance	C _{RSS}				80		
Total Gate Charge	Q _{G(TOT)}				7.5	15	nC
Threshold Gate Charge	Q _{G(TH)}	F			1.1		
Gate-to-Source Charge	Q _{GS}	$V_{GS} = 4.5 \text{ V}, V_{DS} = 15$	$V_{GS} = 4.5 \text{ V}, V_{DS} = 15 \text{ V}; I_D = 10 \text{ A}$		2.0		
Gate-to-Drain Charge	Q _{GD}				3.6		
Gate Resistance	R_{G}				2.4		Ω
SWITCHING CHARACTERISTICS (No	ote 4)		•		•	•	•
Turn-On Delay Time	t _{d(on)}				6.0		ns
Rise Time	t _r	Vge = 10 V. Vpp = 15 \	/. I _D = 1.0 A.		5.0		
Turn-Off Delay Time	t _{d(off)}	V _{GS} = 10 V, V _{DD} = 15 \ R _G = 3.0 Ω			19		
Fall Time	t _f				11		
DRAIN-SOURCE DIODE CHARACTE	RISTICS		•		•	•	•
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 6.25 A	T _J = 25°C		0.79	1.0	V
		- us	T _J = 125°C		0.59		
Reverse Recovery Time	t _{RR}				26		ns
Charge Time	t _a	V_{GS} = 0 V, d_{IS}/d_t = 100 A/ μ s, I_S = 6.25 A			14		
Discharge Time	t _b				12		
Reverse Recovery Charge	Q _{RR}				19		nC

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERIZATIONS

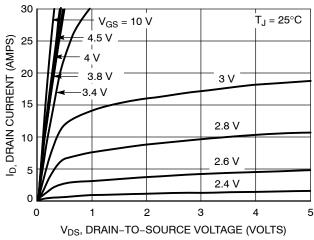


Figure 1. On-Region Characteristics

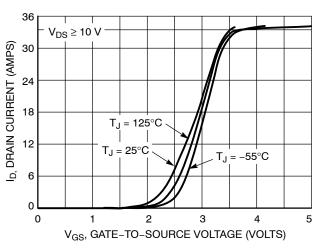


Figure 2. Transfer Characteristics

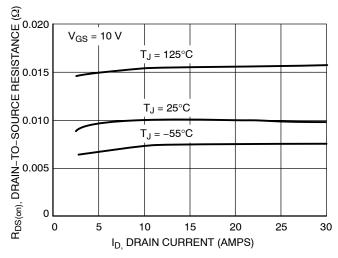


Figure 3. On–Resistance vs. Drain Current and Temperature

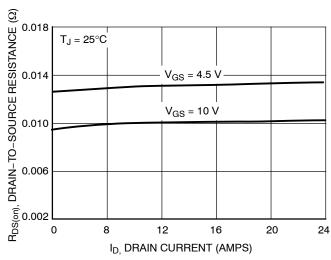


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

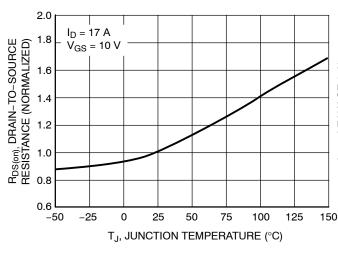


Figure 5. On–Resistance Variation with Temperature

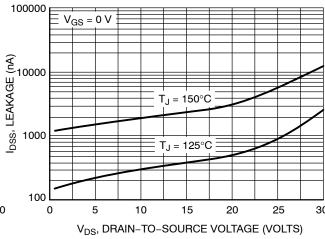
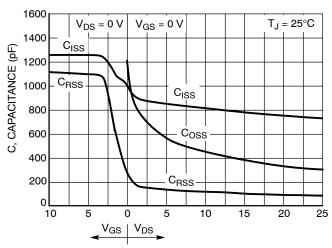
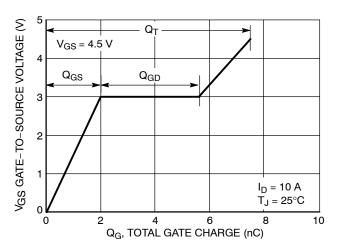


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERIZATIONS

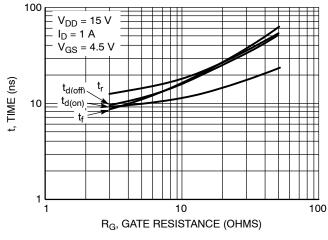




GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (VOLTS)

Figure 7. Capacitance Variation

Figure 8. Gate-To-Source and Drain-To-Source Voltage vs. Total Charge



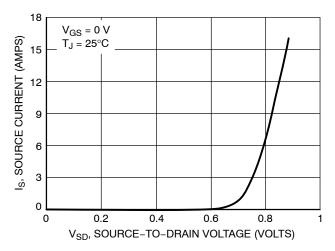
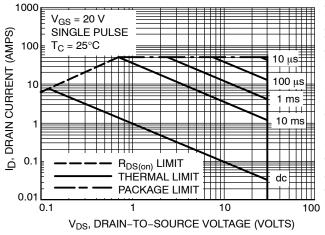


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

Figure 10. Diode Forward Voltage vs. Current



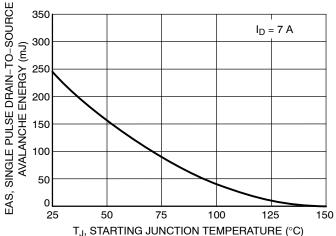


Figure 11. Maximum Rated Forward Biased Safe Operating Area

Figure 12. Maximum Avalanche Energy vs. Starting Junction Temperature



0.10

0.10

SIDE VIEW

DFN5 5x6, 1.27P (SO-8FL) CASE 488AA ISSUE N

DATE 25 JUN 2018

NOTES:

BURRS

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.90	1.00	1.10	
A1	0.00		0.05	
b	0.33	0.41	0.51	
С	0.23	0.28	0.33	
D	5.00	5.15	5.30	
D1	4.70	4.90	5.10	
D2	3.80	4.00	4.20	
E	6.00	6.15	6.30	
E1	5.70	5.90	6.10	
E2	3.45	3.65	3.85	
е	1.27 BSC			
G	0.51	0.575	0.71	
K	1.20	1.35	1.50	
L	0.51	0.575	0.71	
L1	0.125 REF			
M	3.00	3.40	3.80	
A	0 0		12 °	

GENERIC MARKING DIAGRAM*



XXXXXX = Specific Device Code

= Assembly Location Α

Υ = Year W = Work Week ZZ = Lot Traceability

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.





DETAIL A

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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